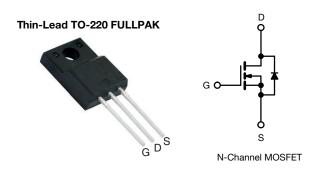
Vishay Siliconix

www.vishay.com

E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 2.38				
Q _g max. (nC)	90				
Q _{gs} (nC)	11				
Q _{gd} (nC)	19				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA2N80E-GE3				

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _{.1} = 150 °C) ^a	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I	2.8	
Continuous drain current $(1_j = 150 \text{ C})^{\alpha}$	VGS AL TO V	T _C = 100 °C	I _D	1.8	А
Pulsed drain current ^b			I _{DM}	5	
Linear derating factor				0.23	W/°C
Single pulse avalanche energy ^c			E _{AS}	14	mJ
Maximum power dissipation	PD	29	W		
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	70	1//20
Reverse diode dv/dt ^d				0.13	V/ns
Soldering recommendations (peak temperature) e For 10 s				260	°C
Mounting torque, M3 screw				0.6	Nm

Notes

a. Limited by maximum junction temperature

b. Repetitive rating; pulse width limited by maximum junction temperature

c. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 0.9 A

d. $I_{SD} \leq I_D, \, di/dt$ = 100 A/µs, starting T_J = 25 °C

e. 1.6 mm from case

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45

9.8

2.4

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 $I_D = 1.0 \text{ A}, V_{DS} = 480 \text{ V}$

19.6

_

nC

DADAMETER	CVMDO!	TVD	MAX.			LINUT	
PARAMETER	SYMBOL	TYP.		UNIT			
Maximum junction-to-ambient	R _{thJA}	- 65 - 4.3			°C/W		
Maximum junction-to-case (drain)	R _{thJC}			0/11			
SPECIFICATIONS (T _J = 25 °C,	unless otherwi	se noted)					
PARAMETER	SYMBOL	TEST CO	ONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	•		
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V	, I _D = 250 μA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to	25 °C, I _D = 1 mA	-	1.0	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}$	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		-	4.0	V
Cata aguras laskaga		$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage	I _{GSS}	V _{GS} :	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA
Zere acts welteres dusis summet		$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V, V _G	_S = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 1.0 A		2.38	2.75	Ω
Forward transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 1.0 A		-	1.0	-	S
Dynamic				•	•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	315	-	
Output capacitance	C _{oss}			-	20	-	1
Reverse transfer capacitance	C _{rss}			-	6	-	1
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	13	-	pF
Effective output capacitance, time	C _o (tr)			-	45	-]

Gate-drain charge	Q _{gd}		-	3.9	-		
Turn-on delay time	t _{d(on)}		-	11	22		
Rise time	t _r	V _{DD} = 480 V, I _D = 1.0 A,	-	7	14	ns	
Turn-off delay time	t _{d(off)}	V_{GS} = 10 V, R_g = 9.1 Ω	-	19	38		
Fall time	t _f		-	27	54		
Gate input resistance	R _g	f = 1 MHz, open drain	1.8	3.6	7.2	Ω	
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I _S	MOSFET symbol showing the	-	-	2.8		
Pulsed diode forward current	I _{SM}	p - n junction diode	-	-	5	A	
Diode forward voltage	V _{SD}	$T_{J} = 25 \ ^{\circ}C, I_{S} = 1 \ A, V_{GS} = 0 \ V$	-	-	1.2	V	
Reverse recovery time	t _{rr}	T 0500 L L 101	-	278	556	ns	
Reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 1.0 A, dI/dt = 100 A/µs, V _B = 25 V	-	0.9	1.8	μC	
Reverse recovery current	I _{RRM}	$a_{\mu}a_{\mu} = 10070 \mu 0, V_{\rm R} = 2000$	-	5	-	А	

 V_{GS} = 10 V

Notes

related ^b

Total gate charge

Gate-source charge

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

C_{o(tr)}

Qg

Q_{gs}

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

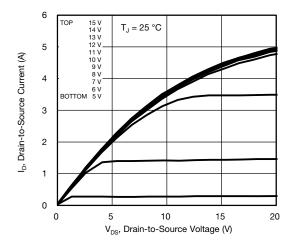
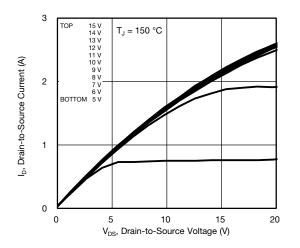
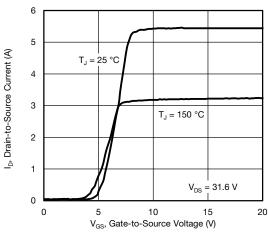


Fig. 1 - Typical Output Characteristics









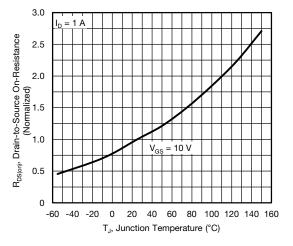


Fig. 4 - Normalized On-Resistance vs. Temperature

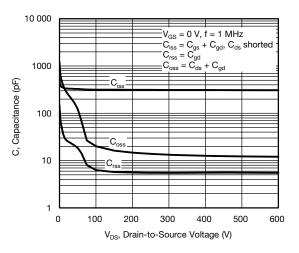


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

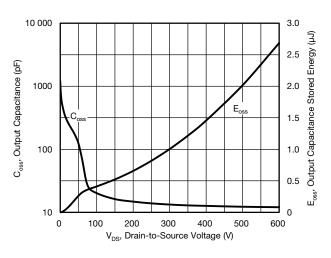


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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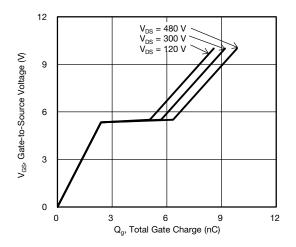


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

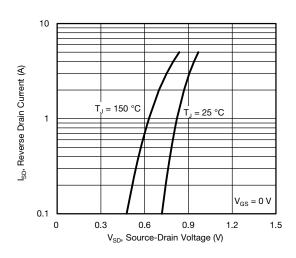


Fig. 8 - Typical Source-Drain Diode Forward Voltage

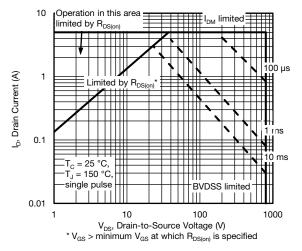


Fig. 9 - Maximum Safe Operating Area

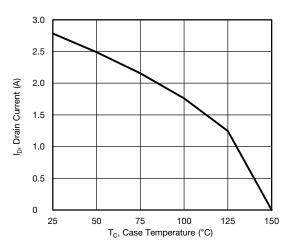


Fig. 10 - Maximum Drain Current vs. Case Temperature

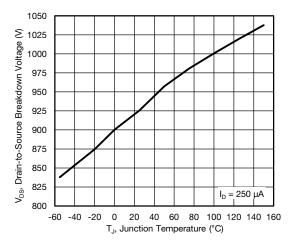


Fig. 11 - Temperature vs. Drain-to-Source Voltage

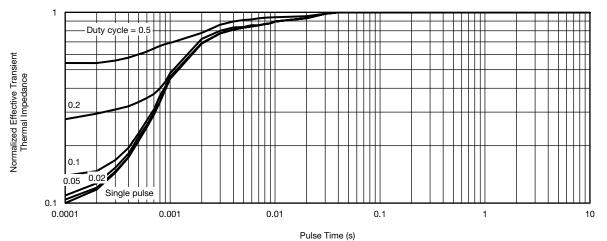
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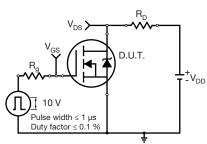


Fig. 13 - Switching Time Test Circuit

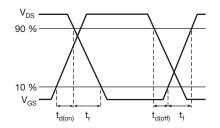


Fig. 14 - Switching Time Waveforms

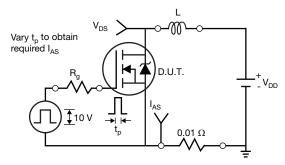


Fig. 15 - Unclamped Inductive Test Circuit

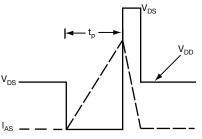


Fig. 16 - Unclamped Inductive Waveforms

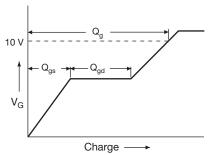


Fig. 17 - Basic Gate Charge Waveform

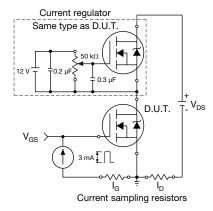


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

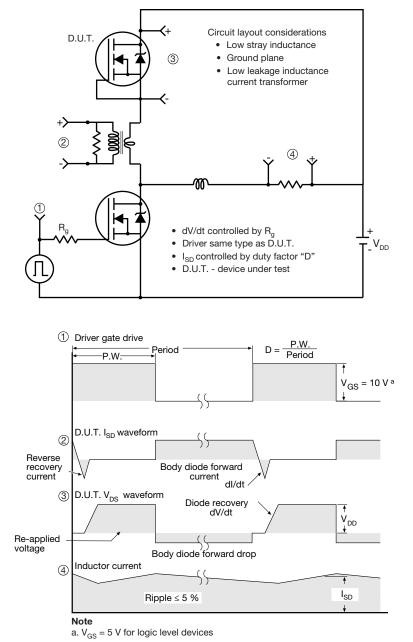


Fig. 19 - For N-Channel

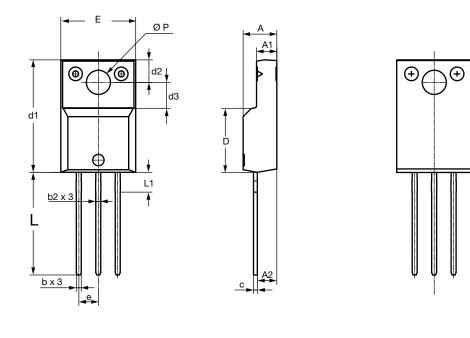
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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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